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April 8, 2004

MAIL STOP PATENT APPLICATION
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Presented for filing is a new original patent application of:

Applicants: Masaaki OYAMADA
Shinji ABE
Akihiro KAWAZOE
Title : CONDUCTIVE ELECTROLESSLY PLATED POWDER AND
METHOD FOR MAKING SAME
Attorney Docket No.: 0092/012001

Enclosed are the following papers, including all those required for a filing date under 37 CFR 1.53(b) :

Pages of Specification	33
Pages of Claims	3
Pages of Abstract	1
Pages of Declaration	2
Pages of Information Disclosure Statement	1
Pages of PTO-1449 Form (in duplicate)	1
Cited References	2

Basic filing fee	770.00
Total claims in excess of 20 times \$18.00	0.00
Independent claims in excess of 3 times \$86.00	0.00
Multiple dependent claims	0.00
Total filing fee:	\$770.00

The \$770.00 fee for filing this application is currently due. Please charge this fee to Deposit Account No. 19-2586, referencing Attorney Docket No. 0092/012001. A duplicate copy of this transmittal letter is attached. It is believed that this fee covers all of the required fees for filing this application, however, if any additional fees are required, please charge these required fees to Deposit Account No. 19-2586, referencing Attorney Docket No. 0092/012001.

If this application is found to be INCOMPLETE, or if any additional fee is required, or if it appears that a telephone conference would helpfully advance prosecution, please telephone the undersigned at 202-530-5900.

Transmittal Letter

Application No. filed concurrently

Applicants: Masaaki OYAMADA et al.

Title : CONDUCTIVE ELECTROLESSLY PLATED POWDER AND
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Kindly acknowledge receipt of this application by returning the enclosed postcard.

Please recognize the following address at the corresponding address:

Customer Number 22893.

Respectfully submitted,



Randolph A. Smith
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RAS:sg
Enclosures
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